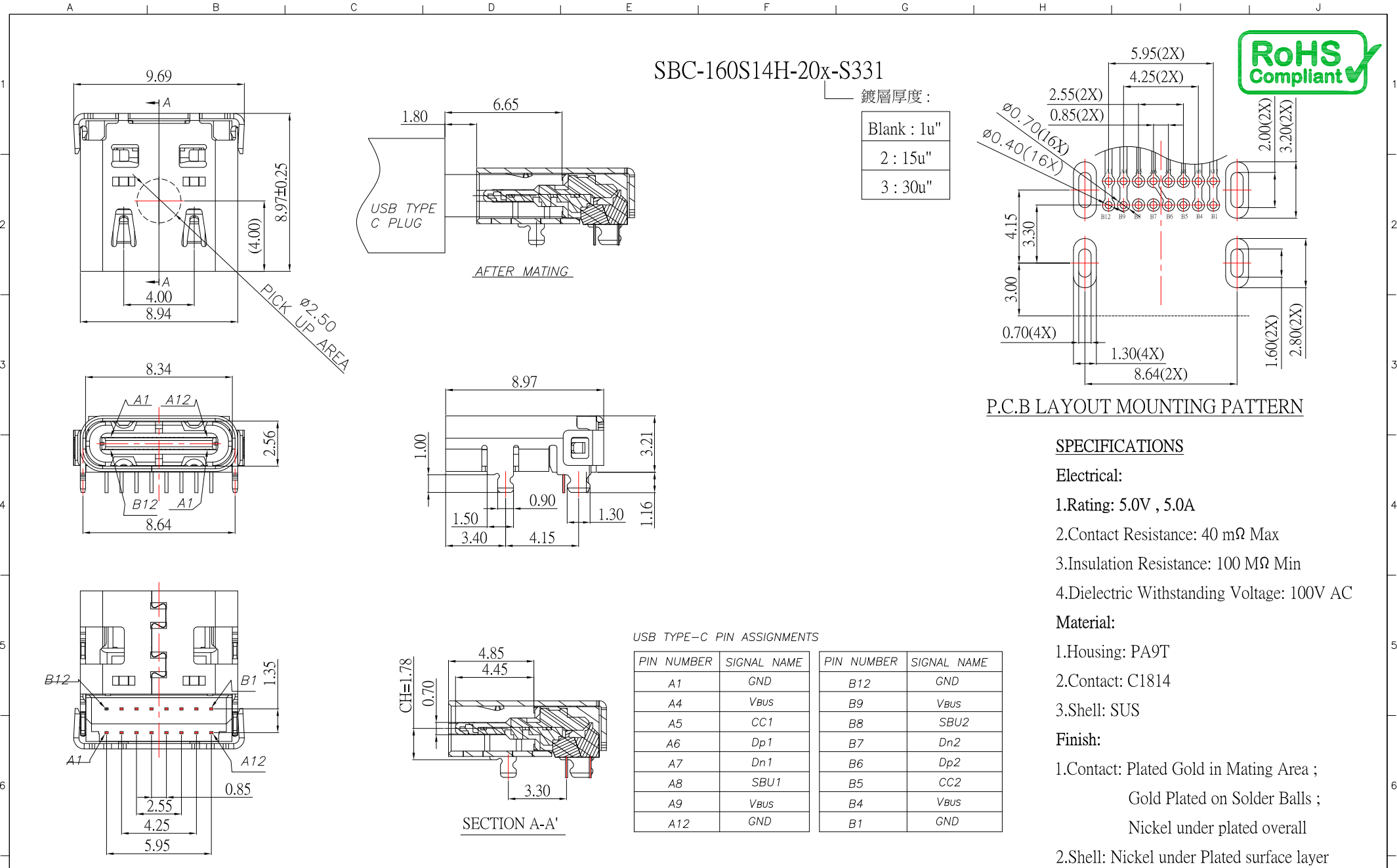


SBC-160S14H-20x-S331

鍍層厚度:

Blank : 1u"
2 : 15u"
3 : 30u"



P.C.B LAYOUT MOUNTING PATTERN

SPECIFICATIONS

Electrical:

- 1.Rating: 5.0V , 5.0A
- 2.Contact Resistance: 40 mΩ Max
- 3.Insulation Resistance: 100 MΩ Min
- 4.Dielectric Withstanding Voltage: 100V AC

Material:

- 1.Housing: PA9T
- 2.Contact: C1814
- 3.Shell: SUS

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer

				CONTACT 建倚科技股份有限公司 CONTACT TECHNOLOGY CORP.				DRAWN BY: DATE		MAT'L		TITLE		CONNECTOR	
								Jack Lu 06/19/23							
								CHECKED BY: DATE		FINISH		MODLE		USB C TYPE 2.0 Female DIP 16PIN 雙排 L8.97m	
				Jacky Chen 06/19/23				SCALE 1 : 1		DWG NO.		SBC-160S14H-20x-S331		SIZE	
				APPROVED BY: DATE										A4	
				Tony Kao 06/19/23				SHEET NO. 1 of 1		PART NO.		SBC-160S14H-20x-S331		VER	
														R	